

L Number	Hits	Search Text	DB	Time stamp
3	382	492/\$.ccls. and (machining or chamfering)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 08:44
4	191	492/\$.ccls. and (machining or chamfering) and layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 08:44
5	59	492/\$.ccls. and (machining or chamfering) same layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:05
6	22	492/\$.ccls. and (jis-a)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/22 10:20
8	7	((492/27).CCLS.) and machining	USPAT	2004/01/22 10:28
12	7	(mixing near resin) and 492/\$.ccls.	USPAT	2004/01/22 13:17
15	75	(heating same mold) and 492/\$.ccls.	USPAT	2004/01/22 13:18

Searched Above m/1/22/04